

General Description

This Super Junction MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for active power factor correction and switching mode power supplies.

FEATURES

- $V_{DSS}=650V$, $I_D=15A$
- Drain-Source ON Resistance :
 $R_{DS(ON)}(\text{Max})=0.28$ @ $V_{GS}=10V$
- $Q_g(\text{typ.})=38nC$

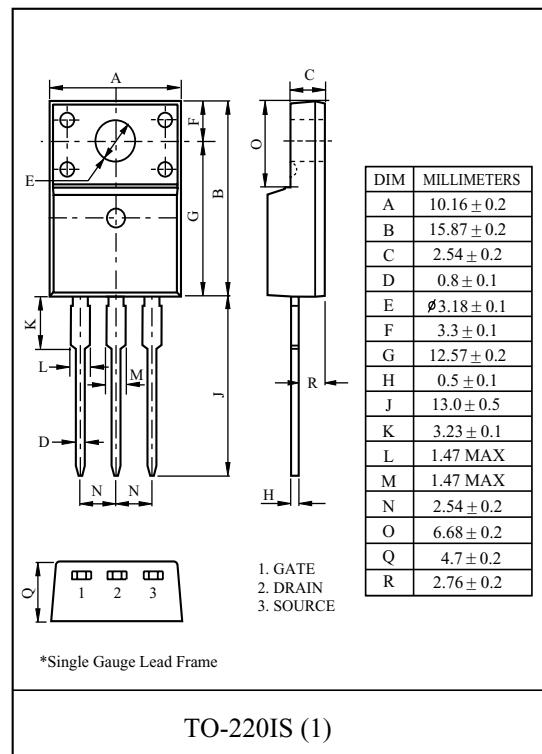
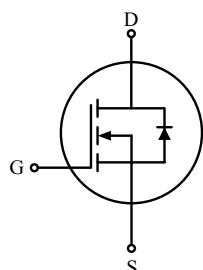
MAXIMUM RATING (T_c=25 °C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DSS}	650	V
Gate-Source Voltage	V_{GSS}	± 30	V
Drain Current	I_D	15*	A
		9.5*	
	I_{DP}	30*	
Single Pulsed Avalanche Energy (Note 2)	E_{AS}	320	mJ
Repetitive Avalanche Energy (Note 1)	E_{AR}	6.0	mJ
Peak Diode Recovery dv/dt (Note 3)	dv/dt	4.5	V/ns
Drain Power Dissipation	P_D	46.3	W
		0.37	W/
Maximum Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

Thermal Characteristics

Thermal Resistance, Junction-to-Case	R_{thJC}	2.7	/W
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62.5	/W

* : Drain current limited by maximum junction temperature.

PIN CONNECTION

KPS15N65F

ELECTRICAL CHARACTERISTICS (Tc=25 °C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250 μA, V _{GS} =0V	650	-	-	V
Breakdown Voltage Temperature Coefficient	BV _{DSS} / T _j	I _D =250 μA, Referenced to 25	-	0.6	-	V/°C
Drain Cut-off Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V	-	-	10	μA
Gate Threshold Voltage	V _{th}	V _{DS} =V _{GS} , I _D =250 μA	2.0	-	4.0	V
Gate Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V	-	-	± 100	nA
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =7.5A	-	0.24	0.28	
Dynamic						
Total Gate Charge	Q _g	V _{DS} =520V, I _D =15A V _{GS} =10V (Note 5)	-	38	-	nC
Gate-Source Charge	Q _{gs}		-	7	-	
Gate-Drain Charge	Q _{gd}		-	20	-	
Turn-on Delay time	t _{d(on)}	V _{DD} =325V I _D =15A R _G =25 (Note 4,5)	-	29	-	ns
Turn-on Rise time	t _r		-	48	-	
Turn-off Delay time	t _{d(off)}		-	110	-	
Turn-off Fall time	t _f		-	45	-	
Input Capacitance	C _{iss}	V _{DS} =40V, V _{GS} =0V, f=1.0MHz	-	1005	-	pF
Output Capacitance	C _{oss}		-	100	-	
Reverse Transfer Capacitance	C _{rss}		-	3	-	
Source-Drain Diode Ratings						
Continuous Source Current	I _S	V _{GS} <V _{th}	-	-	15	A
Pulsed Source Current	I _{SP}		-	-	45	
Diode Forward Voltage	V _{SD}	I _S =15A, V _{GS} =0V	-	-	1.4	V
Reverse Recovery Time	t _{rr}	I _S =15A, V _{GS} =0V, dI _S /dt=100A/μs	-	335	-	ns
Reverse Recovery Charge	Q _{rr}		-	4.5	-	μC

Note 1) Repetitve rating : Pulse width limited by junction temperature.

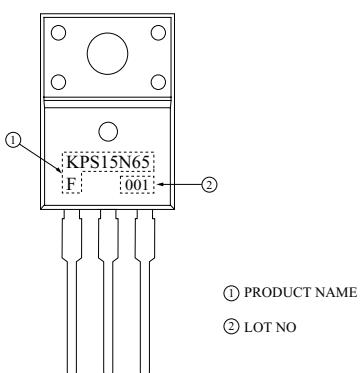
Note 2) L =42.8mH, I_S=3.75A, V_{DD}=50V, R_G=25 Ω, Starting T_j=25 °C.

Note 3) I_S = 15A, dI/dt = 100A/μs, V_{DD} = BV_{DSS}, Starting T_j=25 °C.

Note 4) Pulse Test : Pulse width = 10μs, Duty Cycle = 2%.

Note 5) Essentially independent of operating temperature.

Marking



KPS15N65F

Fig1. I_D - V_{DS}

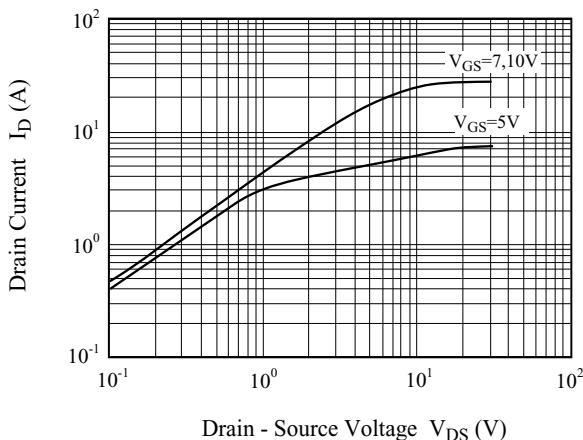


Fig2. I_D - V_{GS}

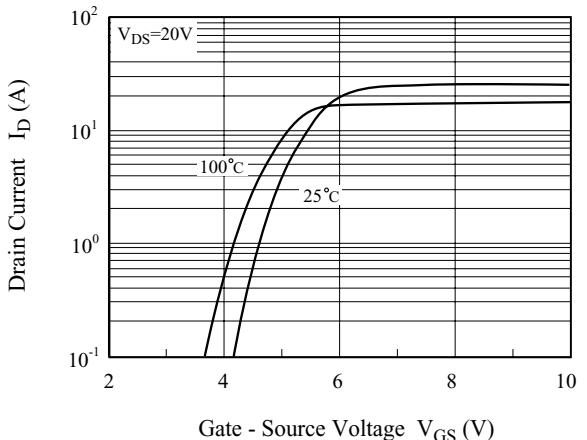


Fig3. BV_{DSS} - T_j

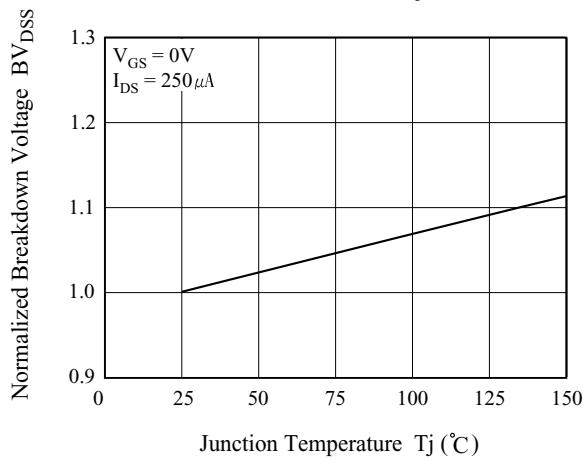


Fig4. $R_{DS(\text{ON})}$ - I_D

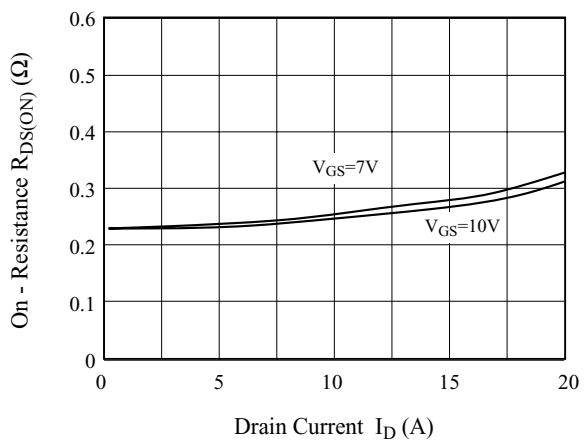


Fig5. I_S - V_{SD}

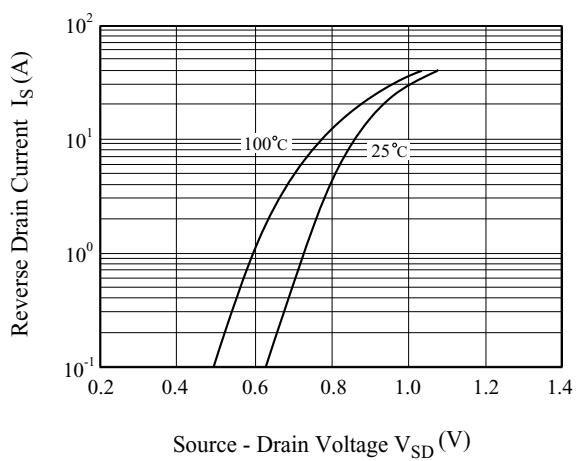
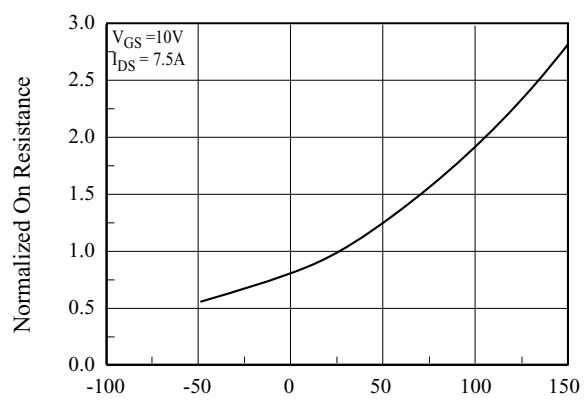


Fig6. $R_{DS(\text{ON})}$ - T_j



KPS15N65F

Fig 7. C - V_{DS}

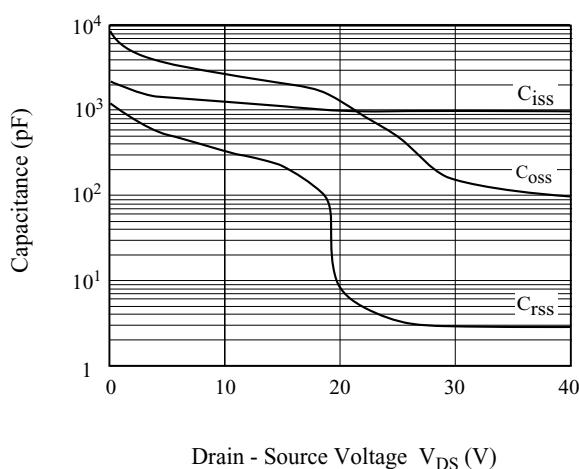


Fig8. Q_g- V_{GS}

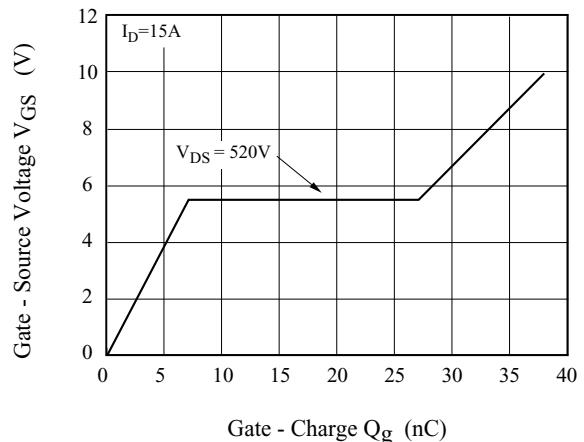


Fig9. Safe Operation Area

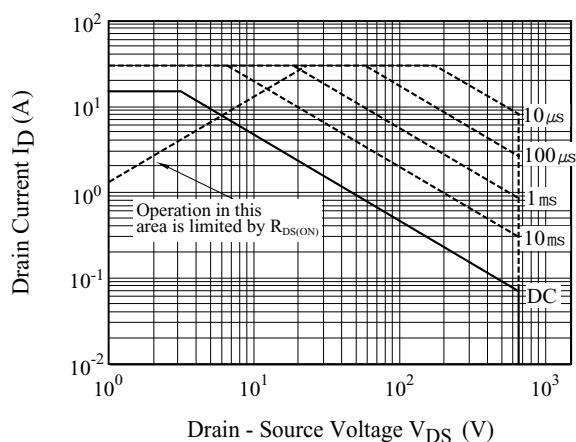
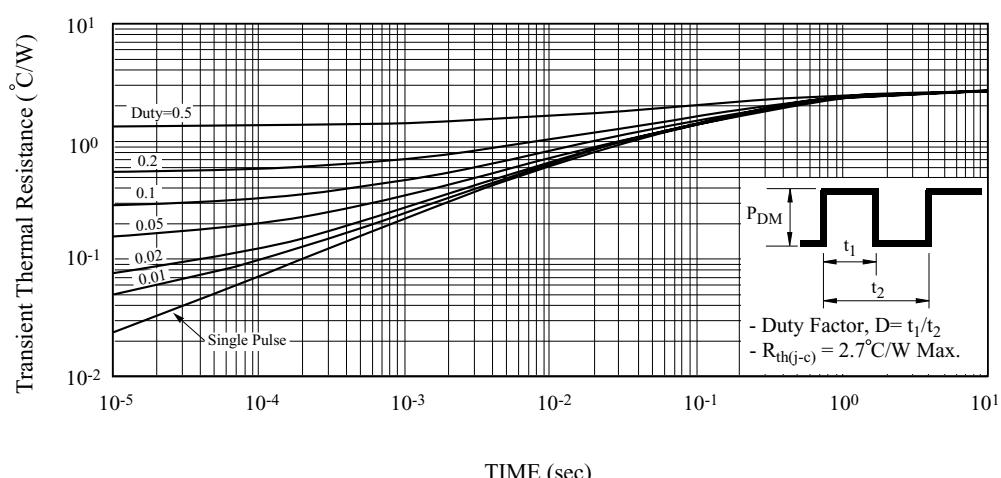


Fig10. Transient Thermal Response Curve



KPS15N65F

Fig11. Gate Charge

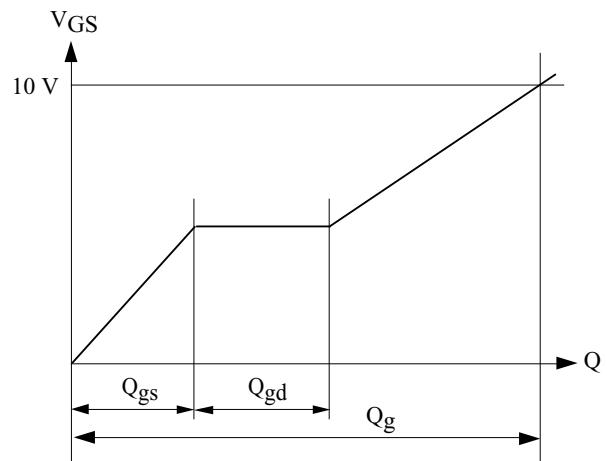
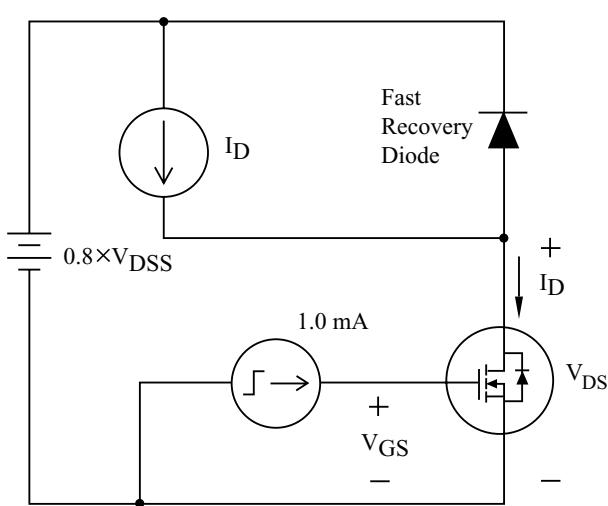


Fig12. Single Pulsed Avalanche Energy

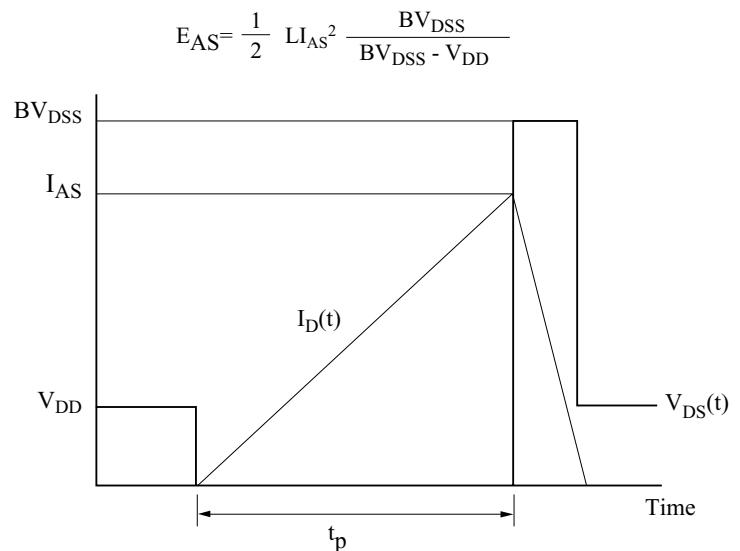
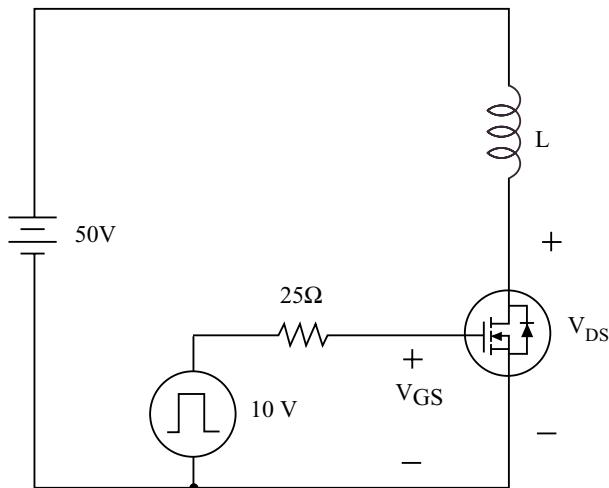
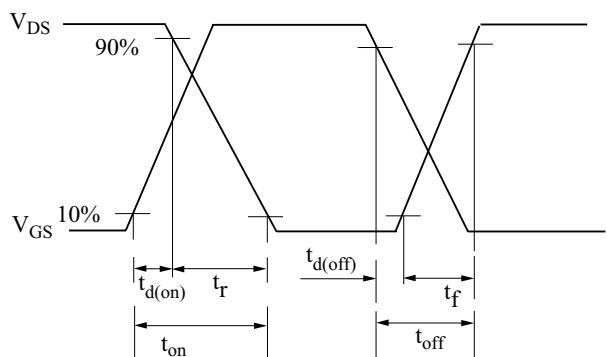
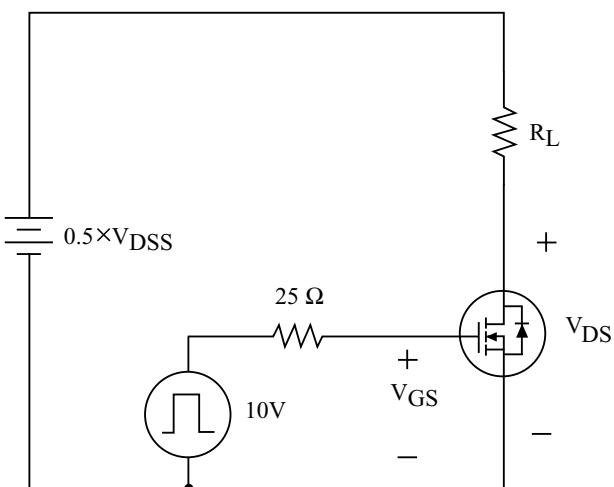


Fig13. Resistive Load Switching



KPS15N65F

Fig14. Source - Drain Diode Reverse Recovery and dv /dt

